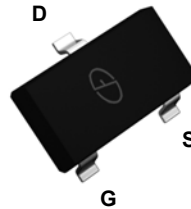
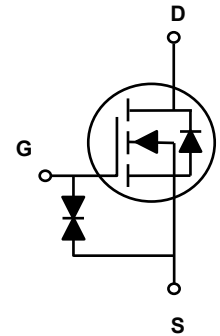


## Main Product Characteristics

$BV_{DSS}$	25V
$R_{DS(ON)}$	230m $\Omega$
$I_D$	0.7A



SOT-23



Schematic Diagram

## Features and Benefits

- Advanced MOSFET process technology
- Ideal for high efficiency switched mode power supplies
- Low on-resistance with low gate charge
- Fast switching and reverse body recovery



## Description

The GSFC0201 utilizes the latest techniques to achieve high cell density and low on-resistance. These features make this device extremely efficient and reliable for use in high efficiency switch mode power supplies and a wide variety of other applications.

## Absolute Maximum Ratings ( $T_C=25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Max.	Unit
Drain-Source Voltage	$V_{DS}$	25	V
Gate-Source Voltage	$V_{GS}$	$\pm 8$	V
Drain Current-Continuous ( $T_A=25^\circ\text{C}$ ) <sup>1,3</sup>	$I_D$	0.7	A
Drain Current-Continuous ( $T_A=70^\circ\text{C}$ ) <sup>1,3</sup>		0.45	
Drain Current-Pulsed <sup>2</sup>	$I_{DM}$	2.5	A
Diode Continuous Forward Current	$I_S$	0.6	A
Power Dissipation ( $T_A=25^\circ\text{C}$ )	$P_D$	0.7	W
Power Dissipation ( $T_A=70^\circ\text{C}$ )		0.4	
Thermal Resistance, Junction-to-Ambient <sup>2</sup>	$R_{\theta JA}$	180	$^\circ\text{C}/\text{W}$
Operating Junction Temperature Range	$T_J$	-55 To +150	$^\circ\text{C}$
Storage Temperature Range	$T_{STG}$	-55 To +150	$^\circ\text{C}$

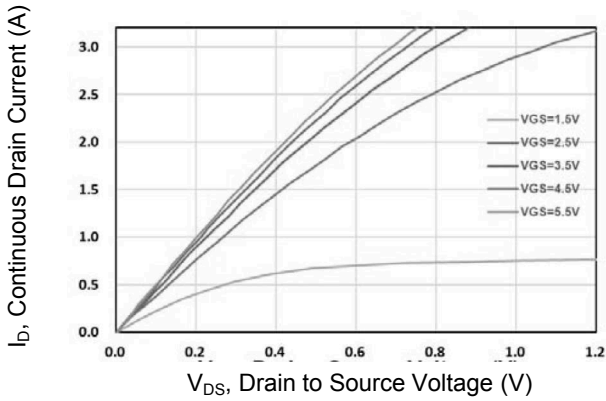
**Electrical Characteristics** ( $T_J=25^{\circ}\text{C}$  unless otherwise specified)

Parameter	Symbol	Conditions	Min.	Typ	Max	Unit
<b>On / Off Characteristics</b>						
Drain-Source Breakdown Voltage	$BV_{DSS}$	$V_{GS}=0V, I_D=250\mu A$	25	-	-	V
Drain-Source Leakage Current	$I_{DSS}$	$V_{DS}=16V, V_{GS}=0V$	-	-	1	$\mu A$
Gate-Source Leakage Current	$I_{GSS}$	$V_{GS}=\pm 8V, V_{DS}=0V$	-	-	$\pm 10$	$\mu A$
Static Drain-Source On-Resistance	$R_{DS(ON)}$	$V_{GS}=4.5V, I_D=0.55A$	-	190	230	m $\Omega$
		$V_{GS}=2.5V, I_D=0.45A$	-	234	305	
		$V_{GS}=1.8V, I_D=0.35A$	-	303	455	
Gate Threshold Voltage	$V_{GS(th)}$	$V_{GS}=V_{DS}, I_D=250\mu A$	0.5	-	1	V
Forward Transconductance	$g_{fs}$	$V_{DS}=5V, I_D=0.55A$	-	1.7	-	S
<b>Dynamic and Switching Characteristics</b>						
Total Gate Charge	$Q_g$	$V_{GS}=2.5V, V_{DS}=10V, I_D=1A$	-	1.1	-	nC
Total Gate Charge	$Q_g$	$V_{DS}=10V, I_D=1A, V_{GS}=4.5V$	-	2	-	nC
Gate-Source Charge	$Q_{gs}$		-	0.3	-	
Gate-Drain Charge	$Q_{gd}$		-	0.3	-	
Turn-On Delay Time	$t_{d(on)}$	$V_{DS}=10V, R_G=6\Omega, V_{GS}=4.5V, I_D=2A$	-	1.2	-	nS
Rise Time	$t_r$		-	25	-	
Turn-Off Delay Time	$t_{d(off)}$		-	14	-	
Fall Time	$t_f$		-	15	-	
Input Capacitance	$C_{iss}$	$V_{DS}=10V, V_{GS}=0V, F=1MHz$	-	43	-	pF
Output Capacitance	$C_{oss}$		-	9	-	
Reverse Transfer Capacitance	$C_{rss}$		-	6	-	
<b>Drain-Source Diode Characteristics and Maximum Ratings</b>						
Diode Forward Voltage	$V_{SD}$	$V_{GS}=0V, I_{SD}=0.35A$	-	-	1.1	V
Reverse Recovery Time	$t_{rr}$	$I_F=1A, di/dt=100A/\mu s$	-	9	-	nS
Reverse Recovery Charge	$Q_{rr}$		-	1	-	nC

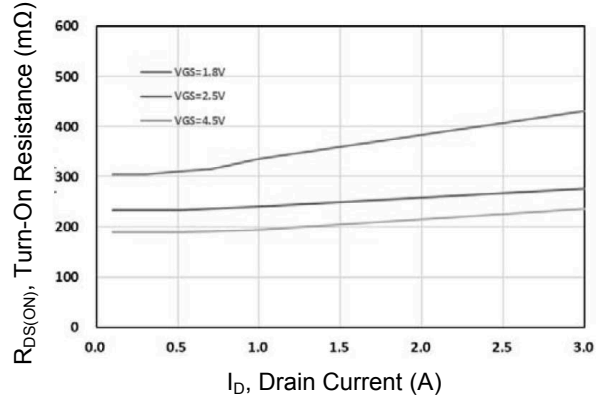
Note:

1. The value of  $R_{\theta JA}$  is measured with the device mounted on 1in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A=25^{\circ}\text{C}$ . The value in any given application depends on the user's specific board design.
2. Repetitive Rating: pulse width limited by maximum junction temperature.
3. The current rating is based on the  $t < 10s$  junction to ambient thermal resistance rating.

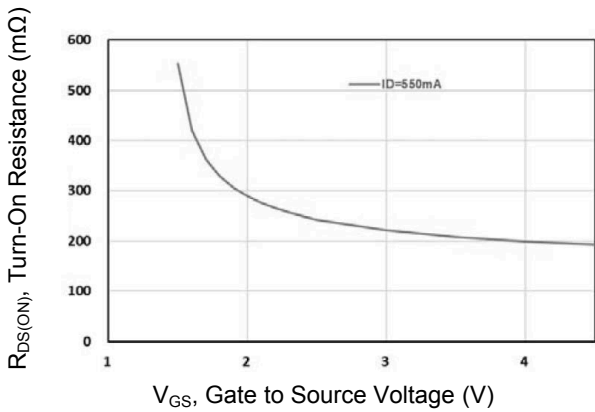
**Typical Electrical and Thermal Characteristic Curves**



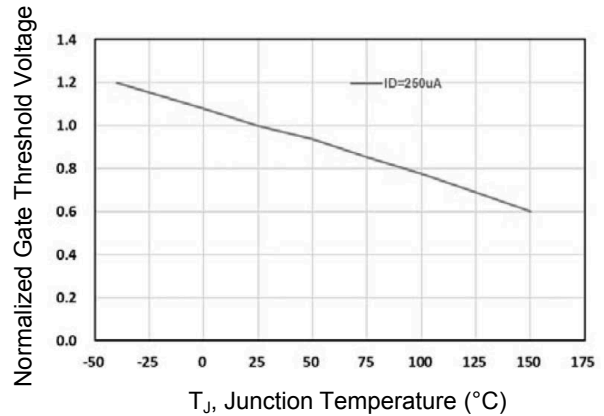
**Figure 1. Typical Output Characteristics**



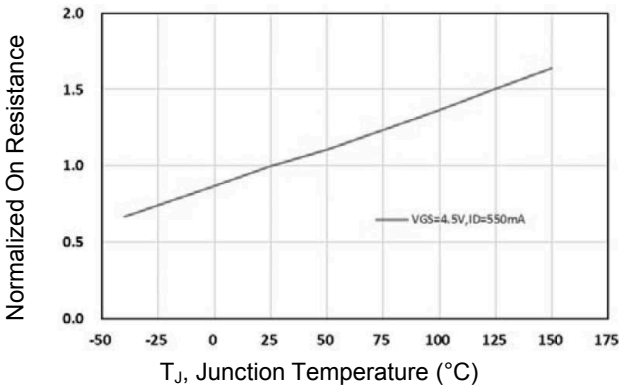
**Figure 2. Turn-On Resistance vs. ID**



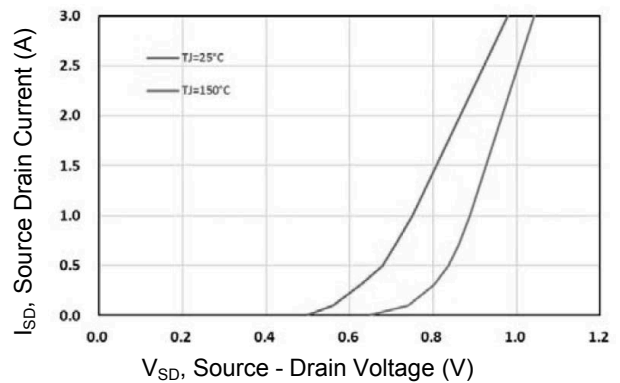
**Figure 3. Turn-On Resistance vs. VGS**



**Figure 4. Normalized Vth vs. TJ**

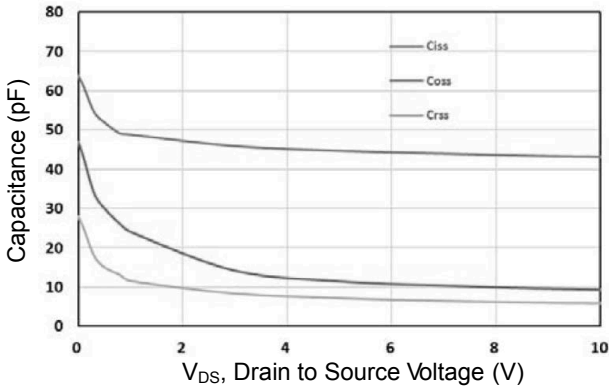


**Figure 5. Normalized RDS(ON) vs. TJ**

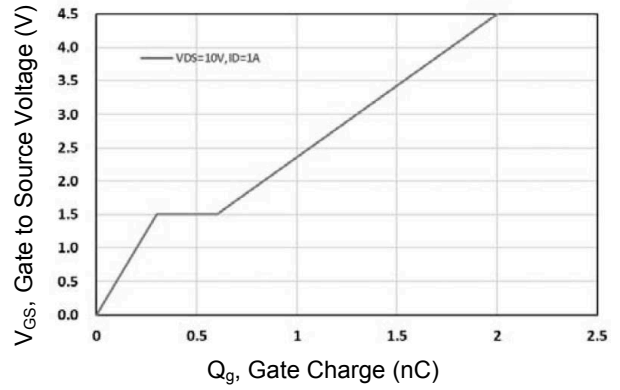


**Figure 6. Typical Source - Drain Diode Forward Voltage**

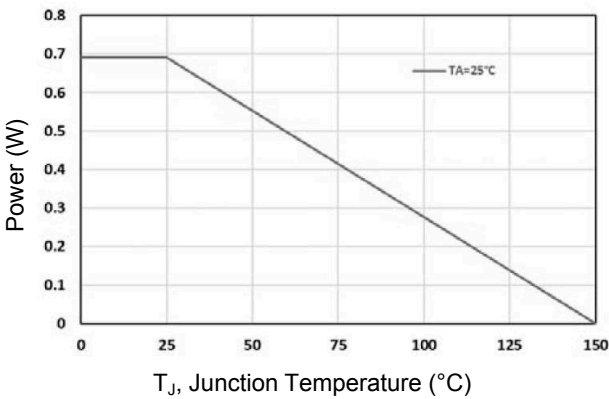
**Typical Electrical and Thermal Characteristic Curves**



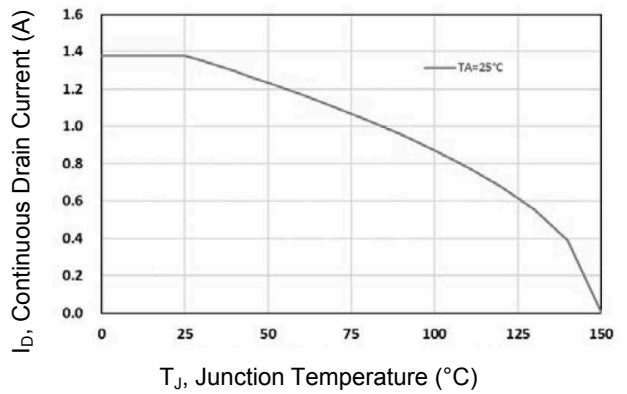
**Figure 7. Capacitance Characteristics**



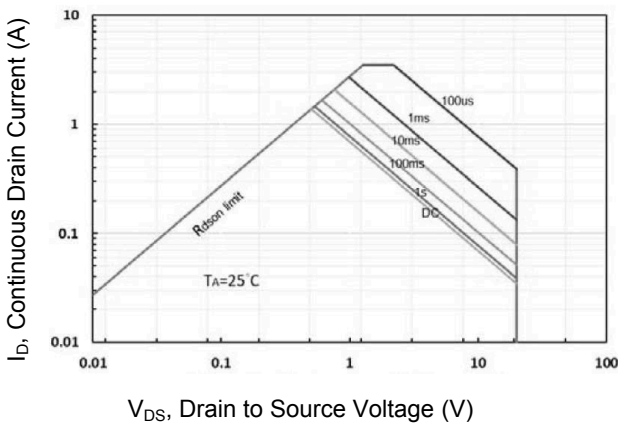
**Figure 8. Gate Charge Characteristics**



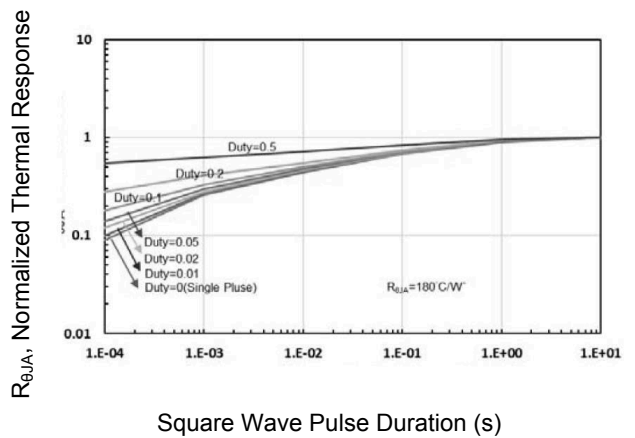
**Figure 9. Power Dissipation**



**Figure 10. Drain Current**

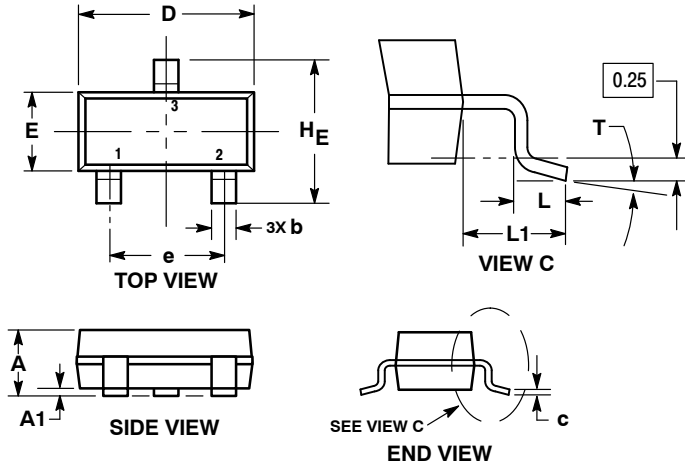


**Figure 11. Maximum Safe Operation Area**



**Figure 12. Normalized Transient Impedance**

**Package Outline Dimensions SOT-23**



Symbol	Dimensions in Millimeters			Dimensions in Inches		
	Min	Nom	Max	Min	Nom	Max
A	0.890	1.000	1.110	0.035	0.039	0.044
A1	0.010	0.060	0.100	0.000	0.002	0.004
b	0.370	0.440	0.500	0.015	0.017	0.020
c	0.080	0.140	0.200	0.003	0.006	0.008
D	2.800	2.900	3.040	0.110	0.114	0.120
E	1.200	1.300	1.400	0.047	0.051	0.055
e	1.780	1.900	2.040	0.070	0.075	0.080
L	0.300	0.430	0.550	0.012	0.017	0.022
L1	0.350	0.540	0.690	0.014	0.021	0.027
H <sub>E</sub>	2.100	2.400	2.640	0.083	0.094	0.104
T	0°	-	10°	0°	-	10°